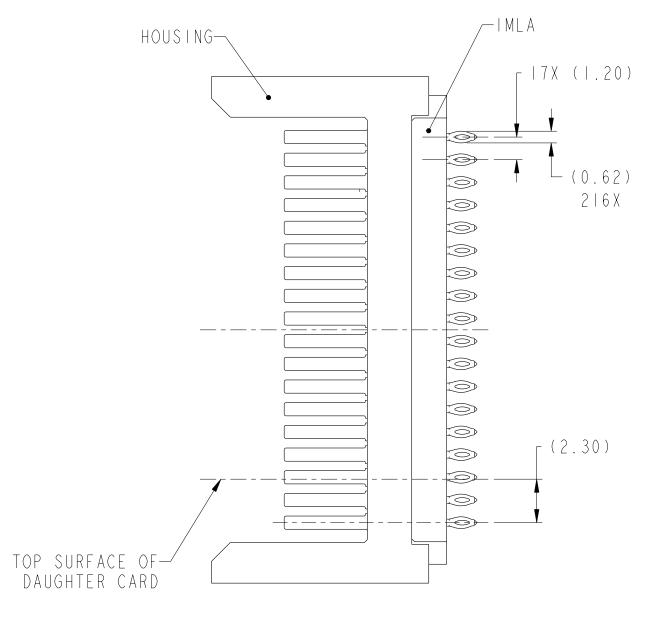


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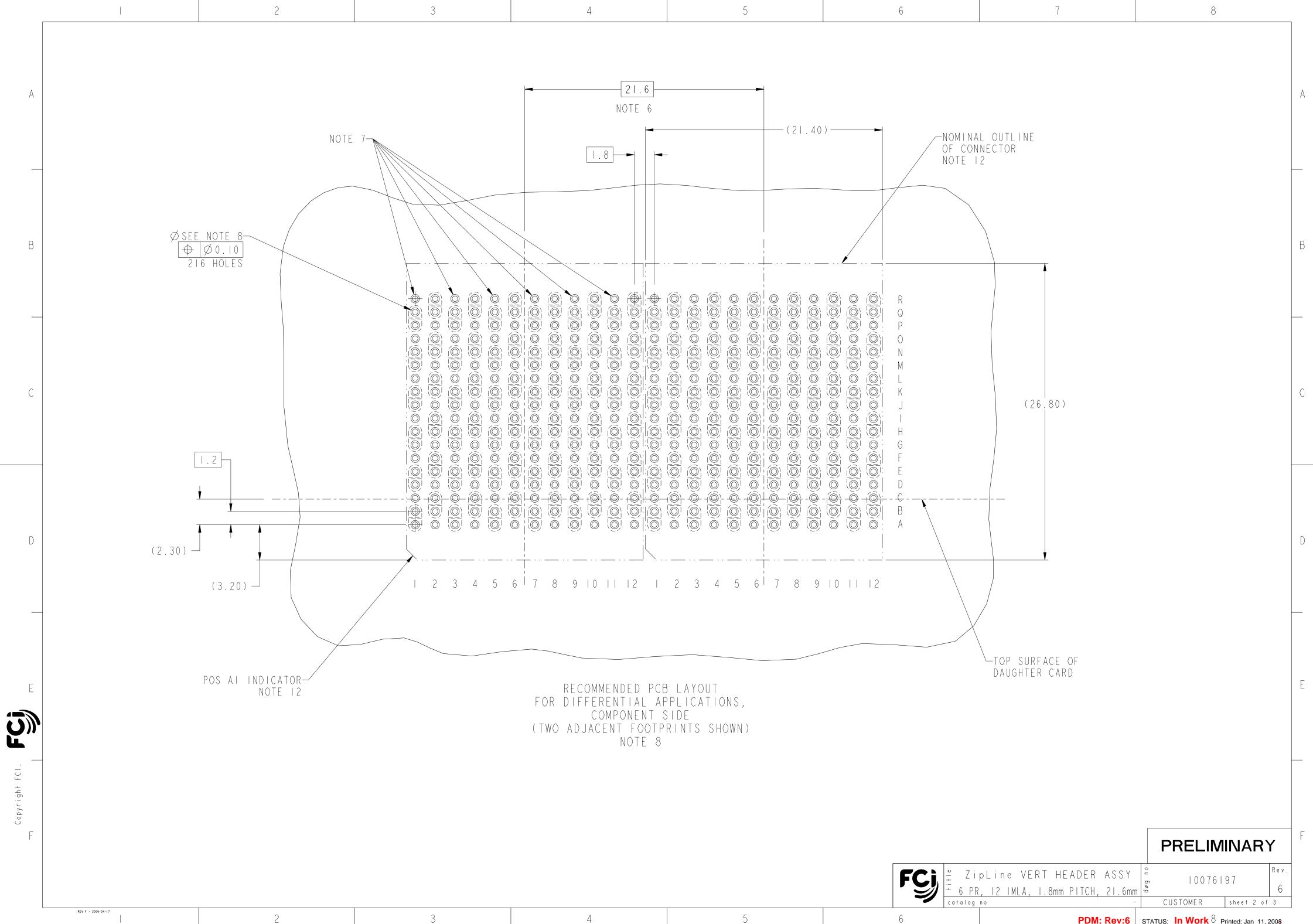
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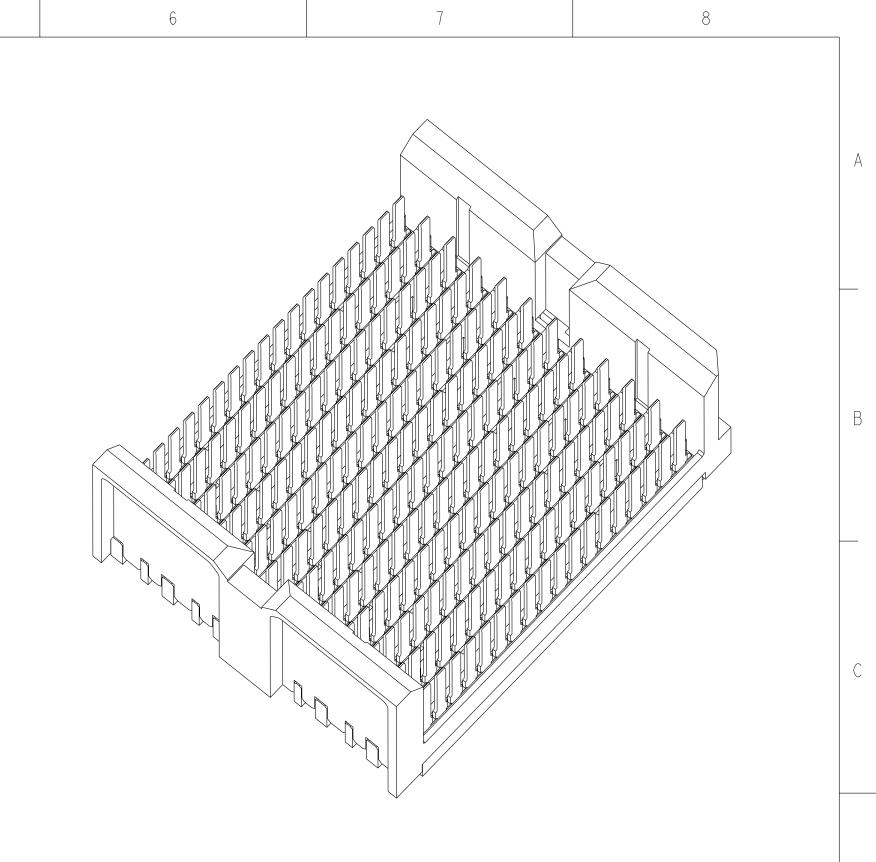
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A 10078197-10 LF N.CKFL CLEAS FREES NOTES: 1. COVALCTOR MAIL: MALES: FOLSING - 1 GH TEMP THERMOPLASTIC, SLACK, U.SZY-O FOLSING - 1 GH TEMP THERMOPLASTIC, SLACK, U.SZY-O FOLSING - 1 GH TEMP THERMOPLASTIC, SLACK, U.SZY-O FOLSING - 1 GH TEMP THERMOPLASTIC, SLACK, U.SZY-O COVALCT P.ATING: 2. COVINCT P.ATING: 2. COVINT P.ATING: 3. COVALCT P.ATING: 4. COVALCT P.ATING: 5. COVALC
<ul> <li>CONNECTOR NATERIALS: HUBLING: IN GHI TEMP THERMOPLASTIC, BLACK, UL94V-0 HUB PLAST C: H GHI TEMP THERMOPLASTIC, BLACK, UL94V-0 CONTACT: COPPER ALLOY         CONTACT: COPPER ALLOY         CONTACT: COPPER ALLOY         CONTACT: COPPER ALLOY         CONTACT: PLATING: SEPARABL: MICHTACE: PERFORMANCE BASED PLATING, OUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION, GS-12-452 INCLUDING TELECORDIA GH-12: 7-CORE KNOVENDER 1995D CENTRAL OFFICE TEST SEQUENCE FRESS-FIT TAILS: SEE TABLE         S. PRODUCT SPECIFICATION: GS-20-094.         S. PRODUCT MARKING, VPART NUMBER &amp; LOT CODED, ON THESE SURFACES.         S. THE VIRIMUM CENTERLINE SPACING BETWEEN ADJACENT VODULES IS 21.6mm.         C         THERE IS NO GROUND BLISSING WITHIN THE HEADER CONNECTOR. HOWEVER POSITIONS PI, R3, R5, R7, R9, A RILL OF THE MATING REFEFTACIEF ARE BUSSED. THESE MUST BE ASSIGNED AS GROUNDS.         S.         RETER TO CUSTOMER DRAWING 10345919 FOR INFORMATION ON PC3 HOLE D AMETERS AND PLATING OPTIONS.         S. THIS PRODUCT MEETS ELROPEAN JIN ON DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN SOCION, DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN SOCION, DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED TO X60°C PFAK TEPPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OF VAPOR PHASE REFLOW OVEN.         H. PACHAGING MEETS SS-14-920 LEAD FREE TO 260°C PHASE REFLOW OVEN.         H. PACKAGING MEETS SS-14-920 LEAD FREE TO 260°C PHASE REFLOW OVEN.         H. PACKAGING MEETS SS-14-920 LEAD FREE LABLE INS SPECIFICATION.         (1) CONNECTION, INFRA-RED OF VAPOR PHASE REFLOW OVEN.         H. PACKAGING MEETS SS-14-920 LEAD FREE LABLE.INS SPECIFICATION.         (2) CONNECTOR OJILINE WITH HOUSING POS AL INDICATOR VAP BE SCEEPEN PRINTED         CONNECTOR OJILINE WITH HOUSING POS AL INDICATOR VAP BE SCEEPEN PRINTED         CONNECTOR OJILINE WITH HOUSING POS AL INDICATOR VAP BE SCEEP</li></ul>
<ul> <li>I. CGNNECTOP WATERTALS: HUBIND: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-8 HUBIND: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-3 CONTACT: COPER ALLOY</li> <li>2. CONTACT: COPER ALLOY</li> <li>2. CONTACT: PLATING: SEPARABLE INTERTACE: PERFORMANCE RASED PLATING, OUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION 6S-12-452 INCLUDING IELCODIA 6V-217-CORE (MOXEMBER 1995) CENTRAL OFFICE TEST SEQUENCE PRESS-111 TALES: SEE TABLE</li> <li>3. PRODUCT SPECIFICATION: 6S-12-452.</li> <li>4. APPLICATION SPECIFICATION: 6S-20-094.</li> <li>(4) PRODUCT WARKING, (FART NUMBER &amp; LOT CODE), ON THESE SURFACES.</li> <li>(5) THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.</li> <li>(7) THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER, POSITIONS RIL, 33, 85, 87, 39, 4, 8111 OF THE MATING RECEPTACIE ARE RUSSED. THESE MUST BE ASSIGNED AS GROUNDS.</li> <li>(8) RETER TO CUSTOMER DRAWING IO063978 FOR INFORMATION ON PCB HGLE DIAMETERS AND PLATING OPTIONS.</li> <li>9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS RIL SCRIPTION.</li> <li>9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIPTION.</li> <li>10. THE PRODUCT MEETS CS-14-920 LEAD FREE TO 260°C PEAK TEMPTRATUBE FCR AS SECONDS IN A CONVECTION, REFARED OF WAYOR PHASE RETION OVEN.</li> <li>11. PACKASING WEETS GS-14-920 LEAD FREE LAUELING SPECIFICATION.</li> <li>(12) CONNECTION OUTLINE WITH HOUSING POS AT INDICATOR MAY BE SCREEN PRINTED</li> </ul>
<ul> <li>CONNECTOR WATERTALS: INUMER PLATTER THE THERMOPLASTIC, BLACK, UL92V-0 INUMER PLATTIC: HIGH THERMOPLASTIC, BLACK, UL92V-0 CONTACT: COPPER ALLOY</li> <li>CONTACT: PLATING: SEPARABLE INTERFACE: TEPFORMANCE-RASED PLATINC, OUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-452 INCLUDING TELECOPIA G4-217-COP: ANOVEMEER 1995) CENTRAL OFFICE TEST SEQUENCE PRESS-TIT TAILS: SEE TABLE</li> <li>PRODUCT SPECIFICATION: GS-12-452.</li> <li>A AFPLICATION SPECIFICATION: GS-28-094.</li> <li>PRODUCT VARKING, (PART NUMBER &amp; LOT CODE), ON THESE SURFACES.</li> <li>THE MINING CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.</li> <li>THERE IS VO SROUND BUSSING WITHIN THE HEADER CONNECTOR HOWEVER POSITIONS RI, 83, 85, 87, 88, 4, 811 OF THE NATING REFEFEATER BUSSED. THESE MUST BE ASSIGNED AS GOUNDS.</li> <li>REFE INCLUSIONER BRAWING HOASSYS FOR INFORMATION ON PED HOLE DIAMETERS AND PLATING OPTIONS.</li> <li>THIS PRODUCT NEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY INSULATIONS AS DESCRIPTION, TOREATED OF 063°C PEAK TEMPERATIRE FOR 42 O SECONDSING NUT INTERATED OF 0740 PEASE BEFLOW OVEN.</li> <li>THEF HOUSING WITH NETHER AND FXPOSURE TO 263°C PEAK TEMPERATIRE FOR 42 O SECONDSING NUT INTERATED OF 0740 PEASE BEFLOW OVEN.</li> <li>THEF HOUSING WITH NETHER AND FXPOSURE TO 263°C PEAK TEMPERATIRE FOR 42 O SECONDSING NUT INTERATED OF 0740 PEASE BEFLOW OVEN.</li> <li>PACKAGING WEETS GS-14-923 LEAD THEE LABELING SPECIFICATION.</li> <li>CONNECTOR OUTLINE WITH HOUSING POS AT INDICATOR MAY BE SCREEN PRINTED</li> </ul>
<ul> <li>HOUSING: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0 INLA PLASTIC: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0 CONTACT: COPPER ALLOY</li> <li>CONTACT: CONTACT: COPPER ALLOY</li> <li>CONTACT: CONTACT PLATING: CONTACT: CONTACT: CONTACT: CONTACT: CONTACT: COPPER ALLOY</li> <li>CONTACT: CONTACT: COPPER ALLOY</li> <li>CONTACT: COPPER ALLOY</li> <li>CONTACT: COPPER ALLOY</li> <li>CONTACT: COPPER ALLOY</li> <li>CONTACT: CONTACT: CONTACT: CONTACT: CONTACT: COPPER ALLOY</li> <li>CONTACT: CONTACT: CONT</li></ul>
<ul> <li>INLA PLASTIC: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-3 CONTACT: COPPER ALLOY</li> <li>CONTACT PLATING: SEPARABLE INTERFACE: PERFORMANCE BASED PLATING, OUALITIED TO MEET THE PROUPEMENTS OF FCF PROBULT SPECIFICATION 6S-12-452 INCLUDING TELCORDIA 6R-217-CORE (NOVEMBER 1385) CENTRAL OFFICE TEST SEQUENCE PRESS-FFIT TALS: SEE TABLE</li> <li>PRODUCT SPECIFICATION: GS-12-452.</li> <li>APPLICATION SPECIFICATION: GS-20-094.</li> <li>PRODUCT MARKING, (PART NUMBER &amp; LOT CODE), ON THESE SURTACES.</li> <li>THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.</li> <li>THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER, POSITIONS R1, R3, R5, R7, R9, &amp; R11 OF THE MATING RECEPTACLE ARE BUSSED. THESE MUST BE ASS (GROUND S.</li> <li>REFER TO CUSTOMER DRAWING 10045919 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLALING OPTIONS.</li> <li>THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN 06-22-008.</li> <li>THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR MAPOR PHASE REFLOW OVEN.</li> <li>PACKAGING MEETS GS-14-920 TEAD FREE LABELING SPECIFICATION.</li> <li>CONNECTOR OUTL NET GROUND FREE LABELING SPECIFICATION.</li> </ul>
SEPARABLE INTERFACE: PERFORMANCE-BASED PLATING, QUALIFIED TO MEET         THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-452 INCLUDING         TELCORDIA GR-1217-CORE (NOVEMBER 1995) CENTRAL OFFICE TEST SEQUENCE         PRESS-FIT TAILS: SEE TABLE         3. PRODUCT SPECIFICATION: GS-12-452.         4. APPLICATION SPECIFICATION: GS-20-094.         ③         ④ PRODUCT MARKING, (PART NUMBER & LOT CODE), ON THESE SURFACES.         ⑥ THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.         ⑦         ⑦ THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER, POSITIONS RI, R3, R5, R7, R9, & RIL OF THE MATING RECEPTACLE ARE BUSSED. THESE MUST BE ASSIGNED AS GROUNDS.         ⑧ REFER TO CUSTOMER DRAWING IO045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.         9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.         10. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.         11. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.         (12) CONNECTOR OUTLINE WITH HOUSING POS AL INDICATOR MAY BE SCREEN PRINTED
TELCORDIA GR-1217-CORE (NOVEMBER 1995) CENTRAL OFFICE TEST SEQUENCE PRESS-FIT TAILS: SEE TABLE         3. PRODUCT SPECIFICATION: GS-12-452.         4. APPLICATION SPECIFICATION: GS-20-094.         (5) PRODUCT MARKING, (PART NUMBER & LOT CODE), ON THESE SURFACES.         (6) THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.         (7) THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER. POSITIONS RI, R3, R5, R7, R9, & RIL OF THE MATING RECEPTACLE ARE BUSSED. THESE MUST BE ASSIGNED AS GROUNDS.         (8) REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.         9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY RECULATIONS AS DESCRIBED IN GS-22-008.         10. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.         11. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.         (12) CONNECTOR OUTLINE WITH HOUSING POS AT INDICATOR MAY BE SCREEN PRINTED
<ul> <li>4. APPLICATION SPECIFICATION: GS-20-094.</li> <li>(5) PRODUCT MARKING, (PART NUMBER &amp; LOT CODE), ON THESE SURFACES.</li> <li>(6) THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.</li> <li>(7) THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER, POSITIONS RI, R3, R5, R7, R9, &amp; RII OF THE MATING RECEPTACLE ARE BUSSED. THESE MUST BE ASSIGNED AS GROUNDS.</li> <li>(8) REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.</li> <li>9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.</li> <li>10. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.</li> <li>11. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.</li> <li>(12) CONNECTOR OUTLINE WITH HOUSING POS AI INDICATOR MAY BE SCREEN PRINTED</li> </ul>
<ul> <li>C</li> <li>THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 21.6mm.</li> <li>C</li> <li>THERE IS NO GROUND BUSSING WITHIN THE HEADER CONNECTOR. HOWEVER, POSITIONS RI, R3, R5, R7, R9, &amp; RII OF THE MATING RECEPTACLE ARE BUSSED. THESE MUST BE ASSIGNED AS GROUNDS.</li> <li>REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.</li> <li>THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.</li> <li>THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.</li> <li>PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.</li> <li>CONNECTOR OUTLINE WITH HOUSING POS AI INDICATOR MAY BE SCREEN PRINTED</li> </ul>
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THESE MUST BE ASSIGNED AS GROUNDS.          (3)       REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.         9.       THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.         10.       THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.         11.       PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.         (12)       CONNECTOR OUTLINE WITH HOUSING POS AI INDICATOR MAY BE SCREEN PRINTED
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(12) CONNECTOR OUTLINE WITH HOUSING POS AI INDICATOR MAY BE SCREEN PRINTED
D ONTO CUSTOMER PCB TO BE USED AS A GUIDE FOR MANUAL CONNECTOR PLACEMENT.
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